

Structure and dielectric properties of amorphous high- κ oxides: HfO₂, ZrO₂, and their alloysYin Wang,^{1,*} Ferdows Zahid,¹ Jian Wang,¹ and Hong Guo^{1,2}¹*Department of Physics and the Center of Theoretical and Computational Physics, The University of Hong Kong, Pokfulam Road, Hong Kong SAR, China*²*Center for the Physics of Materials and Department of Physics, McGill University, Montreal, Quebec, Canada H3A 2T8*
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High- κ metal oxides are a class of materials playing an increasingly important role in modern device physics and technology. Here we report theoretical investigations of the properties of structural and lattice dielectric constants of bulk amorphous metal oxides by a combined approach of classical molecular dynamics (MD), for structure evolution, and quantum mechanical first-principles density function theory (DFT), for electronic structure analysis. Using classical MD based on the Born-Mayer-Buckingham potential function within a melt and quench scheme, amorphous structures of high- κ metal oxides Hf_{1-x}Zr_xO₂ with different values of the concentration x are generated. The coordination numbers and the radial distribution functions of the structures are in good agreement with the corresponding experimental data. We then calculate the lattice dielectric constants of the materials from quantum mechanical first principles, and the values averaged over an ensemble of samples agree well with the available experimental data and are very close to the dielectric constants of their cubic form.

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I. INTRODUCTION

In the complementary metal oxide semiconductor (CMOS) devices, SiO₂ has been the first and only choice of gate oxide material for a long time. However, with the continued decrease in the feature size of the CMOS devices, SiO₂ is no longer reliable as a gate oxide due to the high tunneling leakage current through it at small thickness. Major research efforts are continuously being carried out in search of a suitable replacement for the SiO₂ as a gate material.¹ Several promising candidates are metal oxides such as HfO₂,^{2,3} ZrO₂,³⁻⁵ and Al₂O₃,⁶ all of which have a dielectric constant κ of high value. High- κ metal oxides in their amorphous (a-) form are more preferable as a gate oxide than their crystalline form because of several important advantages they provide: (i) isotropic physical properties; (ii) no crystalline domain boundary, which leads to less defects at the interface with the Si substrate; and (iii) good compatibility with the conventional CMOS fabrication process. Some alloy structures of these high- κ metal oxides are also being studied extensively⁷⁻¹² and, in fact, a Hf-based alloy material has already been in its third generation of production as a gate oxide in the semiconductor industry and further improvements of thermal stability, dielectric constant, and material preparations are under way.⁸⁻¹⁰

In clear contrast to the abundance of experimental results in the literature, theoretical studies of the structure and dielectric properties of amorphous metal oxides and their alloys are quite limited. One of the reasons is the difficulty in generating reasonable and reliable amorphous structures with the available theoretical methods. Experimentally, the high- κ materials are deposited on silicon substrate by vapor deposition (as-deposited films) followed by annealing processes at around 1000 K.^{13,14} Simulating the deposition process and the resulting amorphous high- κ material structures by molecular dynamics (MD) is extremely time-consuming because the deposition rate must be controlled close to the experimental value, which is usually very low. The as-deposited a-HfO₂ and a-Al₂O₃ films have been generated

by kinetic Monte Carlo (KMC) methods^{6,15} with certain assumptions, such as the atoms are kept fixed on predetermined crystal sites and less important dynamics processes of atomic motion are omitted. Both MD and KMC are useful for the simulation of the initial atomic layer deposition processes of the amorphous film growth. To generate bulk amorphous structures, *ab initio* MD simulations can be used in a melt and quench scheme, a-HfO₂,^{3,7,16} a-ZrO₂,^{3,5,17} and their silicates^{7,12} have been successfully simulated this way. The activation-relaxation technique is another method to generate structures of continuous disordered systems¹⁸ and has been applied to generate a-ZrO₂ structures.¹⁷ In this method, one optimizes the structures many times to determine a local energy minima (in configurational space) using a force field which can be calculated from quantum mechanical first principles or described by an empirical potential function. For the former the calculation cost is high while for the latter a reliable potential function is required. Recently, several extended-Tersoff potentials¹⁹ were proposed for certain metal oxides and applied to generate their amorphous structures from classical MD.^{11,20}

Amorphous structures are long range disordered systems which typically require much larger than ~ 100 atoms to simulate. Another issue, perhaps more difficult to deal with, is the simulation time scale that is needed for the atoms to evolve into the amorphous structure. While *ab initio* methods have simulated up to picoseconds time scale, one certainly wishes to investigate the structures and electronic properties of metal oxides at much larger time scales and much larger sizes in order to reveal the long time limit of the structural evolution and the physical properties of the resulting amorphous material. It is the purpose of this work to report such an investigation.

In particular, we calculate the lattice dielectric constants of bulk amorphous metal oxides by a combined approach of classical MD, for structure evolution, and quantum mechanical first-principles DFT, for electronic structure analysis. We overcome the size and time scale difficulty by classical MD simulations in a melt and quench scheme and generate

amorphous structures of HfO_2 , ZrO_2 , and their alloys in the form of $\text{Hf}_{1-x}\text{Zr}_x\text{O}_2$ with different values of the concentration x ($0 < x < 1$). The classical MD is based on the interatomic Born-Mayer-Buckingham potential function.²¹ This potential has been developed over many years and extensively applied to investigate the growth processes of Y_2O_3 , ZrO_2 , and Mg-Al-O thin films.^{22–26} Here we show that high- κ bulk materials of amorphous nature can be generated quite efficiently using this particular potential function. Detailed analysis of the amorphous structures is carried out including the coordination number, the radial distribution function, and the potential energy per atom of the structures. Using the atomic structures generated this way, we carry out first-principles density functional theory (DFT) calculations of the lattice dielectric constant and the results are averaged over ten independent samples for each material. The sample averaged dielectric constants show very good agreement with the corresponding experimental data.

The combined approach of classical MD and DFT is an excellent way to deal with the problem of large sizes and large time scales required by the materials physics of metal oxides. Several advantages can be summarized as follows:

(i) Classical MD is inexpensive for simulating systems containing large number of atoms, which is important for a proper characterization of amorphous structures having long range disorders; here we have gone up to 768 atoms although several thousand atoms can be easily handled.

(ii) In the melt and quench scheme a much longer relaxation time scale, here to several nanoseconds, can be evolved after the material is heated above the melting point. Such a long time scale is important for erasing the memory of the initial structure; thereby the final outcome becomes independent of the initial conditions. Here we show that the same kind of amorphous structure is obtained by evolving from different initial structures including from a completely random structure.

(iii) Since the calculated physical properties of amorphous material should be averaged over an ensemble of samples due to the randomness of the structure, the combined classical-quantum approach allows such a configurational average to be done. Here we show that the calculated dielectric constants of the metal oxides become spatially isotropic after configurational averaging, but it is typically anisotropic if only one sample is calculated.

The paper is organized as follows. In Sec. II we present the classical MD method as employed in this work. In Sec. III we discuss the structural properties of our simulated amorphous structures and also present our results for the lattice dielectric constants of these structures. Section IV concludes the paper.

II. METHODS

In this section we discuss the potential function used in our classical MD simulations along with a short description of the melt and quench scheme. In our MD method the interactions between the atoms are described by the Born-Mayer-Buckingham potential function²¹ as shown below:

$$V(r) = A \exp\left(-\frac{r_{ij}}{\rho}\right) - \frac{C}{r_{ij}^6} + \frac{q_i q_j}{4\pi\epsilon_0 r_{ij}}. \quad (1)$$

TABLE I. Parameters for Born-Mayer-Buckingham potential function as obtained from Ref. 21.

Elements	Charge	A (eV)	ρ (Å)	C
Hf	+4	1454.6	0.350	0
Zr	+4	1453.8	0.350	0
O	-2	22764.3	0.149	20.4

The cation-cation interactions are assumed to be purely Coulombic; the parameters for $\text{O}^{2-}\text{-O}^{2-}$ interactions and cation-anion interactions are presented in Table I. All the parameters were obtained from Ref. 21. We employed Wolf *et al.*'s method^{27,28} for the summation of the Coulomb interaction term.

At the initial stage of the simulation, all the atoms are assigned velocities taken from a Maxwell's distribution at room temperature T_a . The system is then heated up to a temperature of $T_m = 4000$ K, well above the experimental melting point of around 3000 K, followed by an evolution of 5 ns at the same temperature, and then quenched back to room temperature T_a . During this melt and quench process, the motion of an atom is governed by the Langevin equation $m \frac{dv}{dt} = F - \alpha v + F_R$. Actually, the temperature of the system is adjusted by resetting the velocity of a randomly selected atom at the interval of Δt according to the following expression:²⁹

$$v^{\text{new}} = (1 - \theta)^{1/2} v^{\text{old}} + \theta^{1/2} v^{T_m, T_a}(\xi), \quad (2)$$

where θ is a parameter between 0 and 1, and $v^{T_m, T_a}(\xi)$ is a velocity selected randomly from the Maxwell's distribution at temperature T_m or T_a via a random number ξ . Velocity resetting with Eq. (2) corresponds to taking the damping coefficient $\alpha = m\theta/2\Delta t$ and the random force $F_R = m\theta^{1/2}v^T(\xi)/\Delta t$ in the Langevin equation, where m is the atomic mass.²⁹ Previous calculations³⁰ have shown that a value of 0.1 for θ is reasonable and appropriate. After the system is quenched to T_a , it is allowed to evolve for 10 ps to calculate the radial distribution function (RDF). Finally, the system is cooled down to 0 K by a damping method,³¹ and thus concludes the procedure for generating one amorphous structure of a particular metal oxide.

In the simulations, the initial structure is modeled with a $2 \times 2 \times 2$ supercell of $\text{Hf}_{1-x}\text{Zr}_x\text{O}_2$ containing 96 atoms or a $4 \times 4 \times 4$ supercell containing 768 atoms. A periodic boundary condition is imposed on the supercell. The initial atomic configuration is the cubic crystalline form or is in the form of a random structure by *randomly* placing the constituents of the atoms (with the correct ratio) inside the simulation box. These drastically different initial conditions verify that the MD simulation time scales given above are large enough since the same kind of final amorphous structure (similar dielectric constant values and potential energy per atom) is obtained.

III. RESULTS

A. Structure properties of $\text{Hf}_{1-x}\text{Zr}_x\text{O}_2$

To generate reliable amorphous structures it is important to find the optimal density to use for the initial structure. Hence, we first performed a series of independent simulations

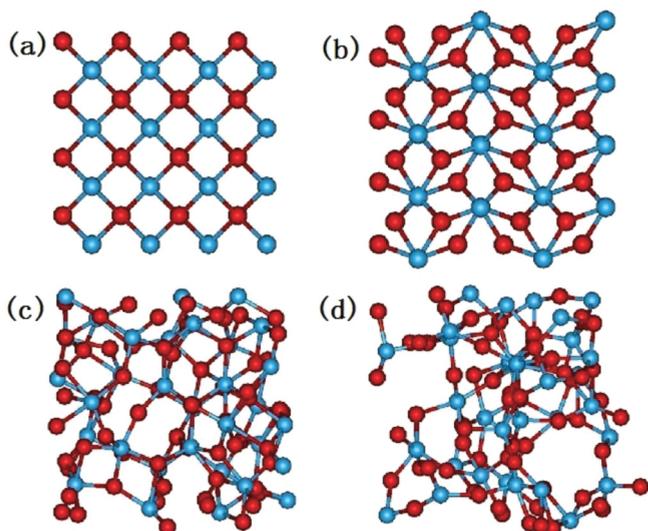


FIG. 1. (Color online) Structures of a-HfO₂ generated by classical MD starting from the cubic crystal form of HfO₂ with different lattice constants, corresponding to different densities. If the density is high, the system recrystallizes to its cubic form (a) or any other crystal form (b); if the density is low, the system tends to form a disordered structure with big holes (d), whereas with a moderate density of 7.97 g/cm³ which corresponds to lattice constant of 5.6 Å for crystalline HfO₂, a reasonable amorphous structure is generated (c). Blue spheres represent Hf atoms; red spheres are for O atoms.

on the 96-atom supercell, starting from initial structures of different lattice constants (i.e., different densities) of cubic HfO₂ and ZrO₂ in the range from 4.5 to 6.0 Å with an interval of 0.1 Å. We found that structures of amorphous nature [see Fig. 1(c)] are obtained when the lattice constant is set to 5.6 Å, which corresponds to a density of 7.97 g/cm³ for HfO₂ and 4.66 g/cm³ for ZrO₂. If we start with a lattice constant less than 5.5 Å, the systems recrystallize to a cubic form [Fig. 1(a)] or some other crystal form [Fig. 1(b)]; while with a lattice constant greater than 5.8 Å, the systems tend to form disordered structures with big holes inside [Fig. 1(d)]. Our optimized density values are close to those obtained previously from *ab initio* calculations which were 8.6 g/cm³ for HfO₂ (Ref. 20) and 4.86 g/cm³ for ZrO₂.¹⁷ Hence, the lattice constant of 5.6 Å is used as the initial condition (cubic form) in subsequent melt and quench evolution to the amorphous structures of Hf_{1-x}Zr_xO₂.

To verify the generated amorphous structures we calculated the coordination numbers and the radial distribution functions. The results are presented in Fig. 2 for a-HfO₂ obtained from the 768-atom supercell. From Fig. 2(a) we note that the three-coordinated O atoms and six-coordinated Hf atoms dominate the a-HfO₂ structures, which agrees with the known *ab initio* results.^{7,16} From Fig. 2(b) we find that the first peaks in the Hf-O, O-O, and Hf-Hf radial distribution functions (RDFs) are at 2.1, 2.8, and 3.6 Å, respectively, which again compares well with *ab initio* studies.^{7,20} These comparisons indicate that classical MD can reliably generate amorphous structures of the metal oxides. Importantly, the efficiency of classical MD allowed us to generate ensembles of amorphous samples of Hf_{1-x}Zr_xO₂ for each given concentration x , which is essential for statistical analysis of the dielectric properties (see below).

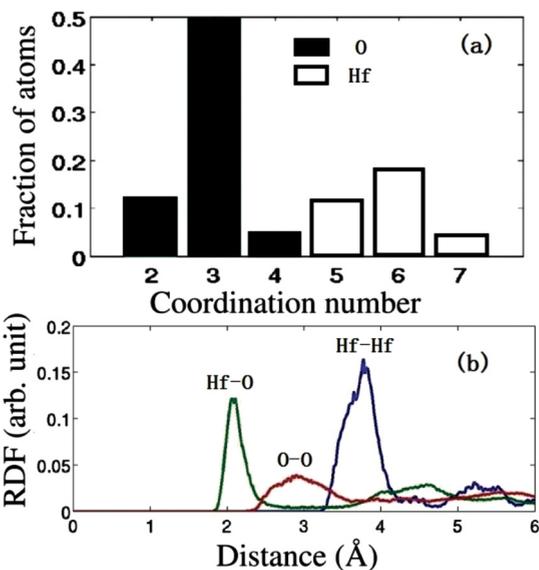


FIG. 2. (Color online) (a) The coordination number and (b) the radial distribution function (RDF) of the amorphous HfO₂ structure obtained by classical MD simulations. Green, red, and blue lines in (b) represent Hf-O, O-O, and Hf-Hf RDF, respectively. The results were obtained from structures having 768 atoms.

For further analysis, we calculated the potential energy per atom of the a-Hf_{1-x}Zr_xO₂ structures for different values of x ranging from 0 to 1 with an interval of 0.125. For each value of x , we generated ten different amorphous samples by varying the initial conditions and then calculated the potential energy per atom for each sample, which is presented in Fig. 3. The results show that the potential energies of a-Hf_{1-x}Zr_xO₂ structures as generated are located in the range from -36.88 to -36.82 eV, which is a reasonable and small spread, higher than that of their crystal forms, and have similar potential energies among themselves. We also generated a structure of a-HfO₂

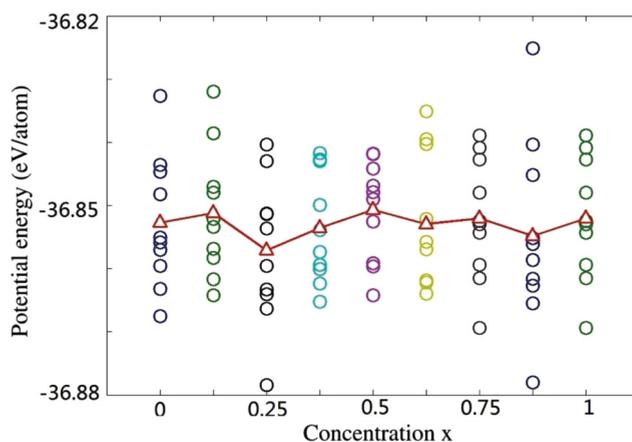


FIG. 3. (Color online) Potential energies per atom for the amorphous structures of Hf_{1-x}Zr_xO₂ averaged over ten samples for each value of x (solid red line). The potential energies per atom for each individual sample are also shown in the figure (circles). The potential energies of these samples reside in the range of -36.88 to -36.82 eV, which is about 0.3 eV higher than that of the cubic HfO₂. The very small differences in the potential energies among the samples with the same value of x confirm the reliability of the structures generated.

starting from an initial system of 32 Hf atoms and 64 O atoms placed *randomly* in a cubic simulation box. The calculated potential energy of this particular a-HfO₂ structure comes to -36.86 eV, which is in the same energy range of the a-HfO₂ structures that were generated from the cubic HfO₂ initial conditions. It is very satisfactory that the generated amorphous structures are not dependent on the initial condition, indicating that the simulation time scales presented above are adequate.

B. Dielectric properties of Hf_{1-x}Zr_xO₂

A most important property of the high- κ metal oxides is their dielectric constant. In this section we present our calculations of the lattice dielectric constant (static) of the Hf_{1-x}Zr_xO₂ amorphous structures generated in the last section. We found that the electronic contribution to the dielectric constant is substantially smaller than the lattice contribution and does not change very much for different structures; hence it is not discussed until when we calculate the total dielectric constant to compare with the measured data (see below).

For the calculations of lattice dielectric constants we employed density functional perturbation theory within a projector augmented wave method in the generalized gradient approximation (GGA) using Perdew-Burke-Ernzerhof (PBE) parametrization as implemented in the VASP software.³² The pseudopotentials for Hf and Zr included only the outermost shells in the valence. An energy cutoff of 400 eV was used in the plane wave by sampling the Brillouin zone only at the Γ point. The MD-generated amorphous structures were not relaxed with DFT in VASP. This is reasonable since we generated by MD a statistical ensemble of structures and the values of the dielectric constant were averaged over the ensemble. For each amorphous structure the dielectric constant was calculated for an ensemble of ten different samples (the 96-atom super cell). The sample averaged values are presented in Table II for a-HfO₂ and a-ZrO₂ along with the dielectric constants for all three of their crystal forms. We notice that the lattice dielectric constants of a-HfO₂ and a-ZrO₂ are close to those of their cubic forms, suggesting that some cubic-like short range order content may dominate the amorphous structures. Indeed, recently experimental measurements¹⁴ on sputtering samples of a-HfO₂ revealed a cubiclike short range coordination in the amorphous microstructure which led to a high measured dielectric constant, $\kappa \sim 30$. Our calculated lattice κ (see Table II) is 24.52; when the electronic contribution which we found to be around 4.4 was added, the total $\kappa \approx 28.9$, which agrees quite well with the measured data. To confirm that the κ of a-HfO₂ being close to that of the cubic HfO₂ is not due to the cubic initial condition of the structure simulation, we evolved a single a-HfO₂ structure from a completely random initial condition (see previous section): its lattice dielectric constant was found to be 21.785,

TABLE II. Calculated lattice dielectric constants for HfO₂ and ZrO₂ relative to the dielectric constants at vacuum.

Oxide	Amorphous	Cubic	Monoclinic	Tetragonal
HfO ₂	24.52	31.08	14.49	125.95
ZrO ₂	35.76	33.80	16.14	26.72

25.43, and 25.163 in the three spatial directions, respectively; its electronic contribution was found to be 4.45. These values are totally consistent with those obtained from the cubic initial conditions.

In comparison with previous theoretical first-principles investigations,^{3,5,17} our κ values are higher. This difference may be explained by noting that in Refs. 3, 5, and 17 the amorphous structures were obtained from a relaxed monoclinic structure with cubic lattice vectors, which tends to have lower κ values. We should mention that direct comparison with experimental measurement is often difficult due to the scarcity of data for dielectric constants of amorphous bulk structures.

Note that the contribution of a given mode to the lattice dielectric constant scales as $\tilde{Z}_\lambda^{*2}/\omega_\lambda^2$, where \tilde{Z}_λ^* is the mode effective charge and ω_λ is the frequency of the λ th ir-active phonon mode; a large κ will be obtained with the existence of modes with simultaneously high \tilde{Z}_λ^* and low ω .^{2,4} It is easy to understand that cubic HfO₂ (ZrO₂) with modes of higher \tilde{Z}_λ^* and lower ω has a larger κ value than a monoclinic structure with modes of lower \tilde{Z}_λ^* and higher ω . The amorphous structures may have similar \tilde{Z}_λ^* and ω values with their cubic forms. This consideration should provide a way to explore possible short range structures within a-Hf_{1-x}Zr_xO₂.

The ensemble averaged lattice dielectric constants of all the amorphous structures generated for different values of the concentration x are presented in Fig. 4. We observe a gradual increase (solid red line) in the values of dielectric constants from a-HfO₂, through Hf_{1-x}Zr_xO₂, to a-ZrO₂. We also note that the spatially resolved dielectric constants in the X, Y, and Z directions (represented by the black symbols in Fig. 4) are quite *isotropic*, which is expected for amorphous structures. It is very important to note that an isotropic dielectric constant is obtained only when the values are averaged over the ensemble of samples of the same structure (same x). For a single sample, we always observe large spreads in the values of dielectric

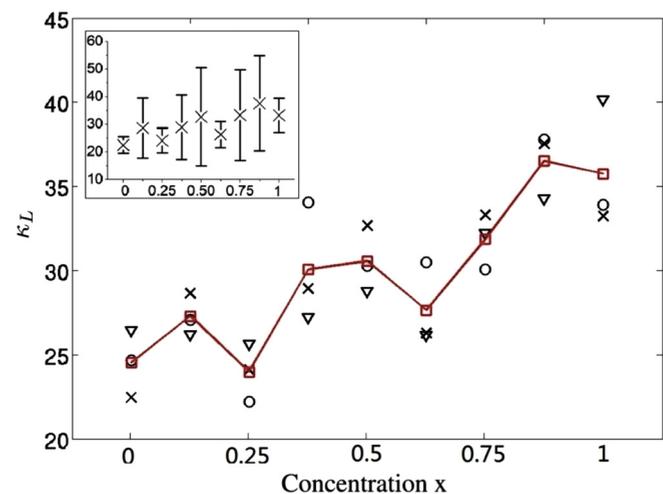


FIG. 4. (Color online) Lattice dielectric constants (κ_L) for the amorphous structures of Hf_{1-x}Zr_xO₂. All the black symbols are for the values in each direction of X, Y, and Z averaged over ten samples, while the square symbols connected with a solid red line represent the values which are averaged over all three directions for each value of x . In the inset the standard deviations of the dielectric constant values over the ten samples along the X direction are presented.

constants in different directions. This finding underpins the major advantage of employing a rather inexpensive classical MD to efficiently generate amorphous structures for the statistical average of the physical properties. Note that all the values of dielectric constants presented in this study are relative to the dielectric constants at vacuum.

IV. SUMMARY

Using classical MD simulations within a melt and quench scheme, the amorphous structures of HfO_2 and ZrO_2 , along with their alloy structures of the form $\text{Hf}_{1-x}\text{Zr}_x\text{O}_2$, have been generated. A suitable potential function, namely the Born-Mayer-Buckingham potential, has been adopted for these simulations. The calculated coordination numbers and radial distribution functions of the generated structures agree well with those of the previous studies. The values of the ensemble

averaged lattice dielectric constants of these amorphous structures are nearly isotropic, close to those of their cubic forms, and compare well with available experimental data.¹⁴ On the other hand, a single sample always produces anisotropic κ values. Our results indicate that the combined approach of classical MD, for structure evolution, and quantum mechanical first-principles DFT, for electronic structure analysis, is a reliable technique for investigating high- κ metal oxides.

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*yinwang@hku.hk

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